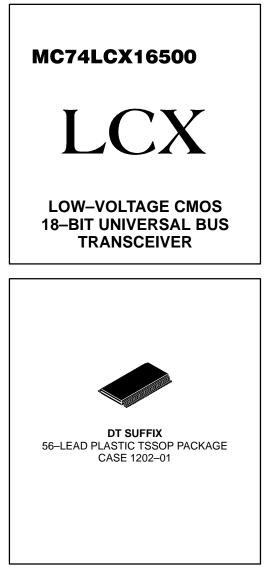
# Low-Voltage CMOS 18-Bit Universal Bus Transceiver With 5V-Tolerant Inputs and Outputs (3-State, Non-Inverting)

The MC74LCX16500 is a high performance, non-inverting 18-bit universal bus transceiver operating from a 2.7 to 3.6V supply. This part is not byte controlled; it is "18-bit" controlled. High impedance TTL compatible inputs significantly reduce current loading to input drivers while TTL compatible outputs offer improved switching noise performance. A V<sub>I</sub> specification of 5.5V allows MC74LCX16500 inputs to be safely driven from 5V devices. The MC74LCX16500 is suitable for memory address driving and all TTL level bus oriented transceiver applications.

<u>Data</u> flow in each direction is controlled by Outp<u>ut Enable</u> (OEAB, OEBA), Latch Enable (LEAB, LEBA) and Clock inputs (CAB, CBA). When LEAB is HIGH, the A-to-B dataflow is transparent. When LEAB is LOW, and CAB is held at LOW or <u>HIGH</u>, the data A is latched; on the HIGH-to-LOW transition of CAB the A-data is stored in the latch/flip-flop. The outputs are active when OEAB is HIG<u>H</u>. When O<u>EAB</u> is LOW the B-outputs are in 3-state. Similarly, the LEBA, OEBA and CBA control the B-to-A dataflow. Please note that the output enables are complementary; OEAB is active HIGH, OEBA is active LOW.

- Designed for 2.7 to 3.6V V<sub>CC</sub> Operation
- 6ns Maximum tpd
- 5V Tolerant Interface Capability With 5V TTL Logic
- Supports Live Insertion and Withdrawal
- IOFF Specification Guarantees High Impedance When V<sub>CC</sub> = 0V
- LVTTL Compatible
- LVCMOS Compatible
- 24mA Balanced Output Sink and Source Capability
- Near Zero Static Supply Current in All Three Logic States (20μA) Substantially Reduces System Power Requirements
- Latchup Performance Exceeds 500mA
- ESD Performance: Human Body Model >2000V; Machine Model >200V



#### **PIN NAMES**

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Pins	Function
<u>OEAB, OE</u> BA	Output Enable Inputs
CAB, CBA	Clock Pulse Inputs
LEAB, LEBA	Latch Enable Inputs
A0–A17	Side A Inputs/Outputs
B0–B17	Side B Inputs/Outputs



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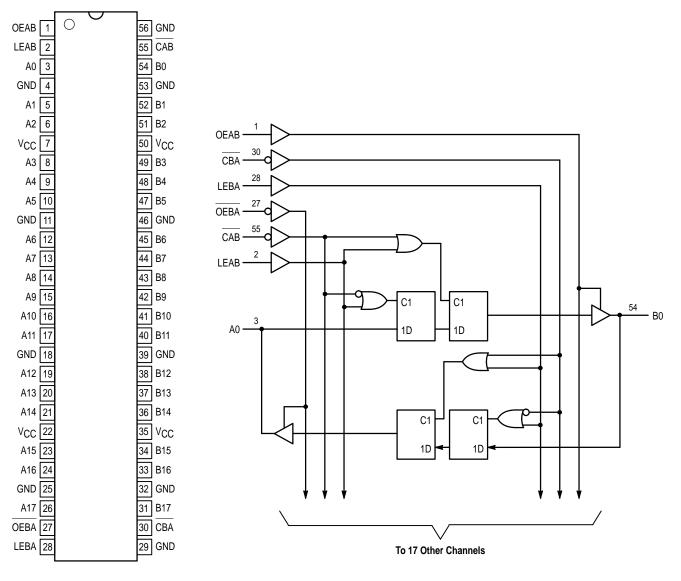




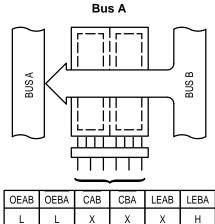
Figure 2. Logic Diagram

### FUNCTION TABLE

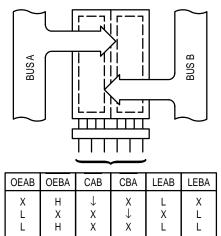
		Inp	uts			Data	Ports	Operating Mede
OEAB	OEBA	LEAB	LEBA	САВ	СВА	An	Bn	Operating Mode
L	н					Input	Input	
				H or L	H or L	Х	Х	Hold Data; A and B Outputs Disabled
		L	L	$\rightarrow$	$\downarrow$	l h	l h	Clock A and/or B Data; A and B Outputs Disabled
Н	Н					Input	Output	
				H or L	X*	Х	QA	Hold and Display B Data
		L	Х	$\rightarrow$	X*	l h	L H	Clock A Data to B Bus; Store A Data
		н	х	х	X*	L H	L H	A Data to B Bus; (Transparent)
L	L					Output	Input	
				Х*	H or L	QB	Х	Hold and Display A Data
		Х	L	Х*	$\downarrow$	LΙ	l h	Clock B Data to A Bus; Store B Data
		х	Н	X*	х	LΗ	L H	B Data to A Bus; (Transparent)
н	L					Output	Output	
		L	L	H or L	H or L	QB	QA	Stored A Data to B Bus; Stored B Data to A Bus

H = High Voltage Level; L = Low Voltage Level; h = High Voltage Level One Setup Time Prior to the Latch Enable or Clock High–to–Low Transition; I = Low Voltage Level One Setup Time Prior to the Latch Enable or Clock High–to–Low Transition; X = Don't Care;  $\downarrow$  = High–to–Low Clock Transition; QA = A Input Storage Register; QB = B Input Storage Register; \* = The clocks are not internally gated with either the Output Enables or the Source Inputs. Therefore, data at the A or B ports may be clocked into the storage registers, at any time. For I<sub>CC</sub> reasons, Do Not Float Inputs.

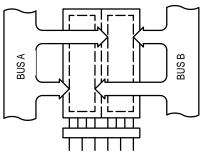
Real Time Transfer – Bus B to



Store Data from Bus A, Bus B or Bus A and Bus B

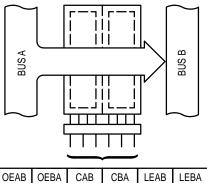


Store Bus A in Both Registers or Store Bus B in Both Registers



OEAB	OEBA	CAB	CBA	LEAB	LEBA
ΗL	H L	X X	X X	L	L





Transfer A Stored Data to Bus B or B Stored Data to Bus A or Both at the Same Time

Х

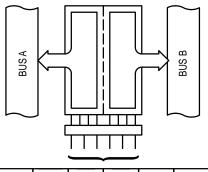
Н

Х

Х

Н

Н



OEAB	OEBA	CAB	CBA	LEAB	LEBA
H	H L L	↓	X	L	X
L		X	↓	X	L
H		H or L	H or L	L	L



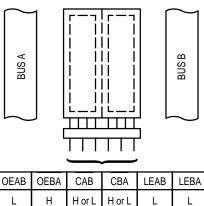


Figure 3. Bus Applications

# **ABSOLUTE MAXIMUM RATINGS\***

Symbol	Parameter	Value	Condition	Unit
VCC	DC Supply Voltage	-0.5 to +7.0		V
VI	DC Input Voltage	$-0.5 \le V_I \le +7.0$		V
VO	DC Output Voltage	$-0.5 \le V_O \le +7.0$	Output in 3–State	V
		$-0.5 \le V_{O} \le V_{CC} + 0.5$	Note 1.	V
liк	DC Input Diode Current	-50	V <sub>I</sub> < GND	mA
юк	DC Output Diode Current	-50	V <sub>O</sub> < GND	mA
		+50	VO > NCC	mA
IO	DC Output Source/Sink Current	±50		mA
ICC	DC Supply Current Per Supply Pin	±100		mA
I <sub>GND</sub>	DC Ground Current Per Ground Pin	±100		mA
T <sub>STG</sub>	Storage Temperature Range	-65 to +150		°C

\* Absolute maximum continuous ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute-maximum-rated conditions is not implied.
1. Output in HIGH or LOW State. I<sub>O</sub> absolute maximum rating must be observed.

# RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Тур	Max	Unit
VCC	Supply Voltage Operating Data Retention Only	2.0 1.5	3.3 3.3	3.6 3.6	V
VI	Input Voltage	0		5.5	V
VO	Output Voltage (HIGH or LOW State) (3–State)	0 0		V <sub>CC</sub> 5.5	V
ЮН	HIGH Level Output Current, V <sub>CC</sub> = 3.0V – 3.6V			-24	mA
I <sub>OL</sub>	LOW Level Output Current, $V_{CC} = 3.0V - 3.6V$			24	mA
Iон	HIGH Level Output Current, $V_{CC} = 2.7V - 3.0V$			-12	mA
IOL	LOW Level Output Current, $V_{CC} = 2.7V - 3.0V$			12	mA
Т <sub>А</sub>	Operating Free–Air Temperature	-40		+85	°C
Δt/ΔV	Input Transition Rise or Fall Rate, V <sub>IN</sub> from 0.8V to 2.0V, V <sub>CC</sub> = $3.0V$	0		10	ns/V

# DC ELECTRICAL CHARACTERISTICS

			T <sub>A</sub> = −40°C	to +85°C	
Symbol	Characteristic	Condition	Min	Max	Unit
VIH	HIGH Level Input Voltage (Note 2.)	$2.7V \le V_{CC} \le 3.6V$	2.0		V
VIL	LOW Level Input Voltage (Note 2.)	$2.7 \text{V} \leq \text{V}_{CC} \leq 3.6 \text{V}$		0.8	V
VOH	HIGH Level Output Voltage	$2.7V \leq V_{CC} \leq 3.6V; \ I_{OH} = -100 \mu A$	V <sub>CC</sub> – 0.2		V
		$V_{CC} = 2.7V; I_{OH} = -12mA$	2.2		
		$V_{CC} = 3.0V; I_{OH} = -18mA$	2.4		
		$V_{CC} = 3.0V; I_{OH} = -24mA$	2.2		
VOL	LOW Level Output Voltage	$2.7V \leq V_{CC} \leq 3.6V; \ I_{OL} = 100 \mu A$		0.2	V
		V <sub>CC</sub> = 2.7V; I <sub>OL</sub> = 12mA		0.4	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 16mA		0.4	
		V <sub>CC</sub> = 3.0V; I <sub>OL</sub> = 24mA		0.55	

2. These values of V<sub>1</sub> are used to test DC electrical characteristics only.

# DC ELECTRICAL CHARACTERISTICS (continued)

			T <sub>A</sub> = −40°C to +85°C		
Symbol	Characteristic	Condition	Min	Max	Unit
Ц	Input Leakage Current	$2.7V \le V_{CC} \le 3.6V; \ 0V \le V_I \le 5.5V$		±5.0	μA
loz	3-State Output Current	$2.7 \leq V_{CC} \leq 3.6 \text{V}; \ 0 \text{V} \leq \text{V}_O \leq 5.5 \text{V}; \\ \text{V}_I = \text{V}_{IH} \text{ or } \text{V}_{IL}$		±5.0	μΑ
IOFF	Power–Off Leakage Current	$V_{CC} = 0V; V_I \text{ or } V_O = 5.5V$		10	μA
ICC	Quiescent Supply Current	$2.7 \leq V_{CC} \leq 3.6 \text{V}; \ \text{V}_{I} = \text{GND} \ \text{or} \ \text{V}_{CC}$		20	μΑ
		$2.7 \leq V_{CC} \leq 3.6 \text{V}; \ 3.6 \leq \text{V}_{I} \text{ or } \text{V}_{O} \leq 5.5 \text{V}$		±20	μA
ΔICC	Increase in I <sub>CC</sub> per Input	$2.7 \leq V_{CC} \leq 3.6 \text{V}; \text{ V}_{IH} = V_{CC} - 0.6 \text{V}$		500	μA

# AC CHARACTERISTICS (Note 3.; $t_R = t_F = 2.5ns$ ; $C_L = 50pF$ ; $R_L = 500\Omega$ )

				Lir	nits		
				T <sub>A</sub> = −40°	C to +85°C		
			V <sub>CC</sub> = 3.	0V to 3.6V	V <sub>CC</sub> :	= 2.7V	
Symbol	Parameter	Waveform	Min	Max	Min	Max	Unit
f <sub>max</sub>	Maximum Clock Frequency	3	170				MHz
<sup>t</sup> PHL <sup>t</sup> PLH	Propagation Delay Input to Output	1	1.5 1.5	6.0 6.0	1.5 1.5	7.0 7.0	ns
<sup>t</sup> PHL <sup>t</sup> PLH	Propagation Delay Clock to Output	3	1.5 1.5	6.7 6.7	1.5 1.5	8.0 8.0	ns
<sup>t</sup> PHL <sup>t</sup> PLH	Propagation Delay LExx to Output	4	1.5 1.5	7.0 7.0	1.5 1.5	8.0 8.0	ns
<sup>t</sup> PZH <sup>t</sup> PZL	Output Enable Time to High and Low Level	2	1.5 1.5	7.2 7.2	1.5 1.5	8.2 8.2	ns
<sup>t</sup> PHZ <sup>t</sup> PLZ	Output Disable Time From High and Low Level	2	1.5 1.5	7.0 7.0	1.5 1.5	8.0 8.0	ns
t <sub>S</sub>	Setup Time	3,4	2.5		2.5		ns
<sup>t</sup> h	Hold Time	3,4	1.5		1.5		ns
t <sub>w</sub>	Pulse Width Time	3,4	3.0		3.0		ns
<sup>t</sup> OSHL <sup>t</sup> OSLH	Output-to-Output Skew (Note 4.)			1.0 1.0			ns

3. These AC parameters are preliminary and may be modified prior to release.

4. Skew is defined as the absolute value of the difference between the actual propagation delay for any two separate outputs of the same device. The specification applies to any outputs switching in the same direction, either HIGH-to-LOW (t<sub>OSHL</sub>) or LOW-to-HIGH (t<sub>OSLH</sub>); parameter guaranteed by design.

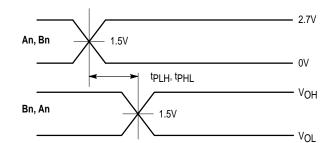
# DYNAMIC SWITCHING CHARACTERISTICS

			T <sub>A</sub> = +25°C			
Symbol	Characteristic	Condition	Min	Тур	Max	Unit
VOLP	Dynamic LOW Peak Voltage (Note 5.)	$V_{CC}$ = 3.3V, $C_{L}$ = 50pF, $V_{IH}$ = 3.3V, $V_{IL}$ = 0V		0.8		V
VOLV	Dynamic LOW Valley Voltage (Note 5.)	$V_{CC}$ = 3.3V, $C_{L}$ = 50pF, $V_{IH}$ = 3.3V, $V_{IL}$ = 0V		0.8		V

5. Number of outputs defined as "n". Measured with "n–1" outputs switching from HIGH-to-LOW or LOW-to-HIGH. The remaining output is measured in the LOW state.

# **CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Condition	Typical	Unit
C <sub>IN</sub>	Input Capacitance	$V_{CC} = 3.3V$ , $V_I = 0V$ or $V_{CC}$	7	pF
C <sub>I/O</sub>	Input/Output Capacitance	$V_{CC}$ = 3.3V, $V_{I}$ = 0V or $V_{CC}$	8	pF
C <sub>PD</sub>	Power Dissipation Capacitance	10MHz, V_{CC} = 3.3V, V_{I} = 0V or V_{CC}	20	pF



WAVEFORM 1 - An to Bn PROPAGATION DELAYS  $t_R = t_F = 2.5ns$ , 10% to 90%; f = 1MHz;  $t_W = 500ns$ 

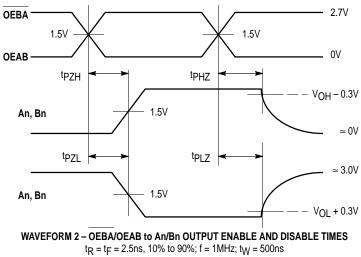
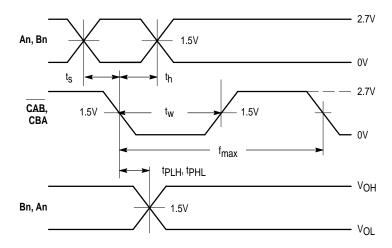
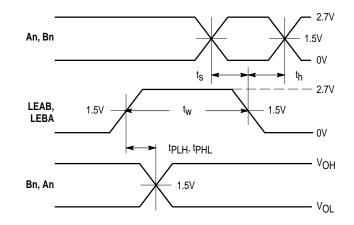


Figure 4. AC Waveforms

# MC74LCX16500



WAVEFORM 3 – CLOCK to Bn/An PROPAGATION DELAYS, CLOCK MINIMUM PULSE WIDTH, An/Bn to CLOCK SETUP AND HOLD TIMES  $t_R = t_F = 2.5ns$ , 10% to 90%; f = 1MHz;  $t_W = 500ns$  except when noted



WAVEFORM 4 – LExx to An, Bn PROPAGATION DELAYS, LExx MINIMUM PULSE WIDTH, An, Bn to LExx SETUP AND HOLD TIMES  $t_R = t_F = 2.5ns$ , 10% to 90%; f = 1MHz;  $t_W = 500ns$  except when noted

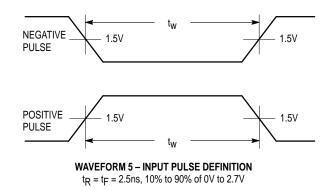
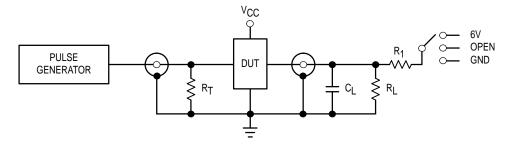


Figure 5. AC Waveforms (continued)

# MC74LCX16500

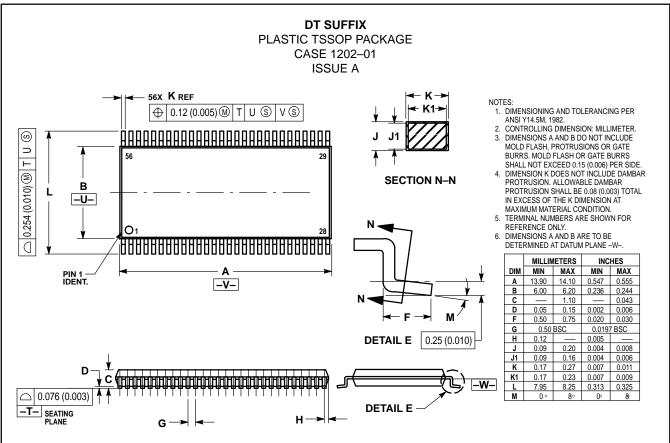


TEST	SWITCH
tPLH, tPHL	Open
tPZL, tPLZ	6V
Open Collector/Drain tPLH and tPHL	6V
<sup>t</sup> PZH <sup>, t</sup> PHZ	GND

 $C_L = 50 pF$  or equivalent (Includes jig and probe capacitance)  $R_L = R_1 = 500\Omega$  or equivalent  $R_T = Z_{OUT}$  of pulse generator (typically 50 $\Omega$ )



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